

BLP10H660P; BLP10H660PG

Power LDMOS transistor

AMPLEON

Rev. 1 — 20 December 2016

Product data sheet

1. Product profile

1.1 General description

A 60 W LDMOS power transistor for broadcast and industrial applications in the HF to 1000 MHz band.

Table 1. Application information

Test signal	f	V _{DS}	P _L	G _p	η _D
	(MHz)	(V)	(W)	(dB)	(%)
pulsed RF	720	50	60	18	72

1.2 Features and benefits

- Easy power control
- Integrated dual sided ESD protection enables class C operation and complete switch off of the transistor
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (HF to 1000 MHz)
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLP10H660P (SOT1223-2)			
1	gate 2		
2	gate 1		
3	drain 1		
4	drain 2		
5	source [1]		
BLP10H660PG (SOT1224-2)			
1	gate 2		
2	gate 1		
3	drain 1		
4	drain 2		
5	source [1]		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLP10H660P	HSOP4F	plastic, heatsink small outline package; 4 leads (flat)	SOT1223-2
BLP10H660PG	HSOP4	plastic, heatsink small outline package; 4 leads	SOT1224-2

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	110	V
V_{GS}	gate-source voltage		-6	+11	V
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature	[1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

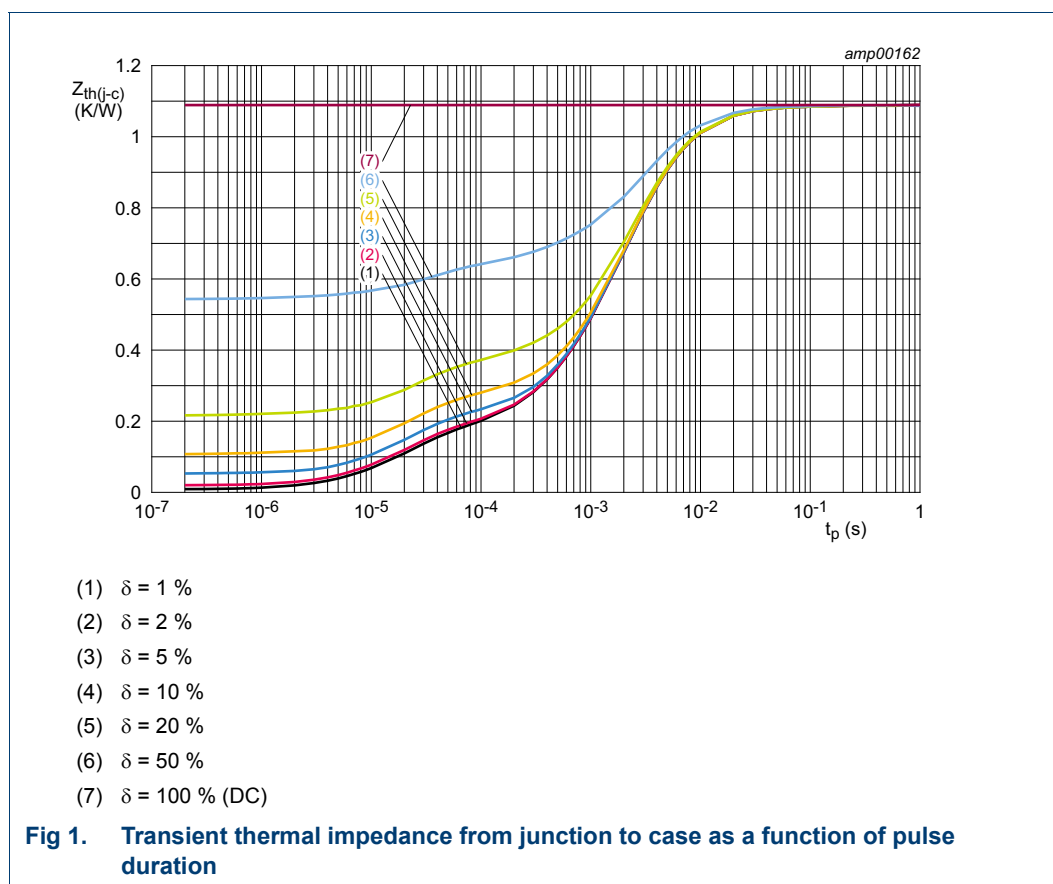
Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	$T_j = 125\text{ °C}$ [1][2]	1.1	K/W
$Z_{th(j-c)}$	transient thermal impedance from junction to case	$T_j = 150\text{ °C}$; $t_p = 100\text{ }\mu\text{s}$; $\delta = 20\text{ %}$ [3]	0.37	K/W

[1] T_j is the junction temperature.

[2] $R_{th(j-c)}$ is measured under RF conditions.

[3] See Figure 1.



6. Characteristics

Table 6. DC characteristics

$T_j = 25\text{ °C}$; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0\text{ V}$; $I_D = 250\text{ }\mu\text{A}$	110	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 10\text{ V}$; $I_D = 25\text{ mA}$	1.25	1.9	2.25	V
V_{GSq}	gate-source quiescent voltage	$V_{DS} = 50\text{ V}$; $I_D = 10\text{ mA}$	-	1.7	-	V
I_{DSS}	drain leakage current	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$	-	-	1.4	μA

Table 6. DC characteristics ...continued
 $T_j = 25\text{ }^\circ\text{C}$; per section unless otherwise specified.

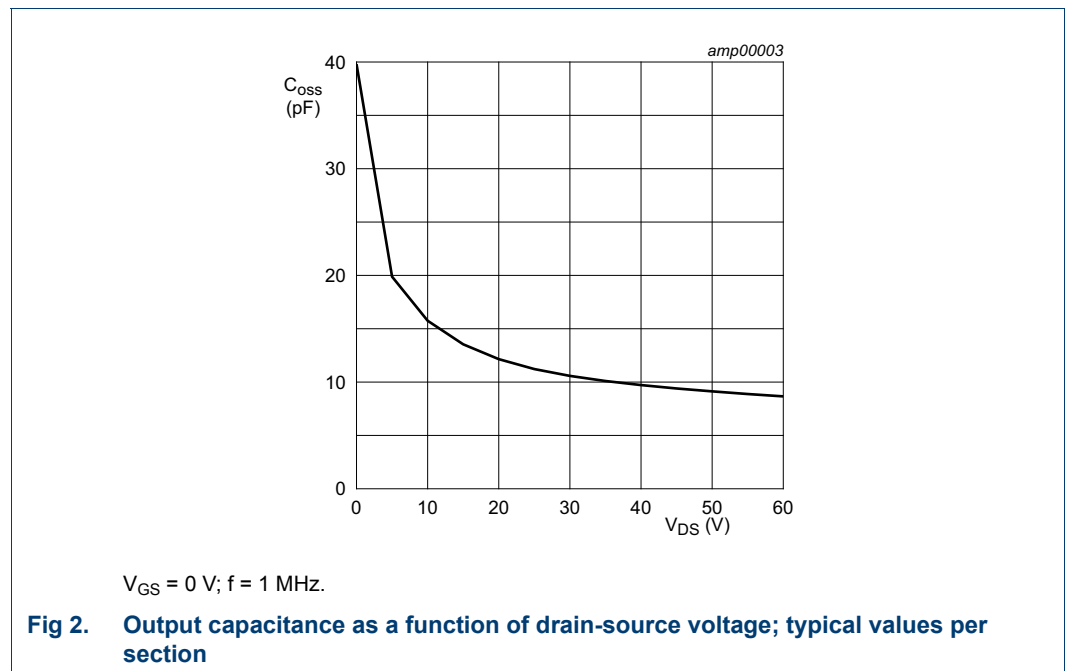
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75\text{ V}$; $V_{DS} = 10\text{ V}$	-	3.9	-	A
I_{GSS}	gate leakage current	$V_{GS} = 11\text{ V}$; $V_{DS} = 0\text{ V}$	-	-	140	nA
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75\text{ V}$; $I_D = 0.87\text{ A}$	-	1.2	-	Ω

Table 7. AC characteristics
 $T_j = 25\text{ }^\circ\text{C}$; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
C_{rs}	feedback capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	-	0.15	-	pF
C_{iss}	input capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	-	28.7	-	pF
C_{oss}	output capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	-	9.1	-	pF

Table 8. RF characteristics
 Test signal: pulsed RF; $t_p = 100\text{ }\mu\text{s}$; $\delta = 20\%$; $f = 720\text{ MHz}$; RF performance at $V_{DS} = 50\text{ V}$;
 $I_{Dq} = 40\text{ mA}$; $T_{case} = 25\text{ }^\circ\text{C}$; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$P_L = 60\text{ W}$	16.8	18	-	dB
RL_{in}	input return loss	$P_L = 60\text{ W}$	-	-28	-	dB
η_D	drain efficiency	$P_L = 60\text{ W}$	70	72	-	%



7. Test information

7.1 Ruggedness in class-AB operation

The BLP10H660P and BLP10H660PG are capable of withstanding a load mismatch corresponding to VSWR > 40 : 1 through all phases under the following conditions: $V_{DS} = 50\text{ V}$; $I_{Dq} = 40\text{ mA}$; $P_L = 60\text{ W}$ pulsed; $f = 720\text{ MHz}$.

7.2 Impedance information

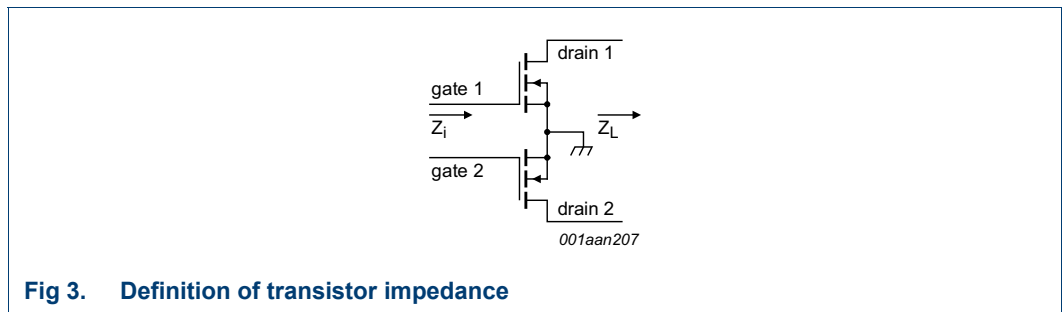


Fig 3. Definition of transistor impedance

Table 9. Typical push-pull impedance

Simulated Z_i and Z_L device impedance; impedance info at $V_{DS} = 50\text{ V}$ and $P_L = 60\text{ W}$.

f	Z_i	Z_L
(MHz)	(Ω)	(Ω)
720	$8.0 - j16.2$	$16.6 + j22.8$

7.3 Test circuit

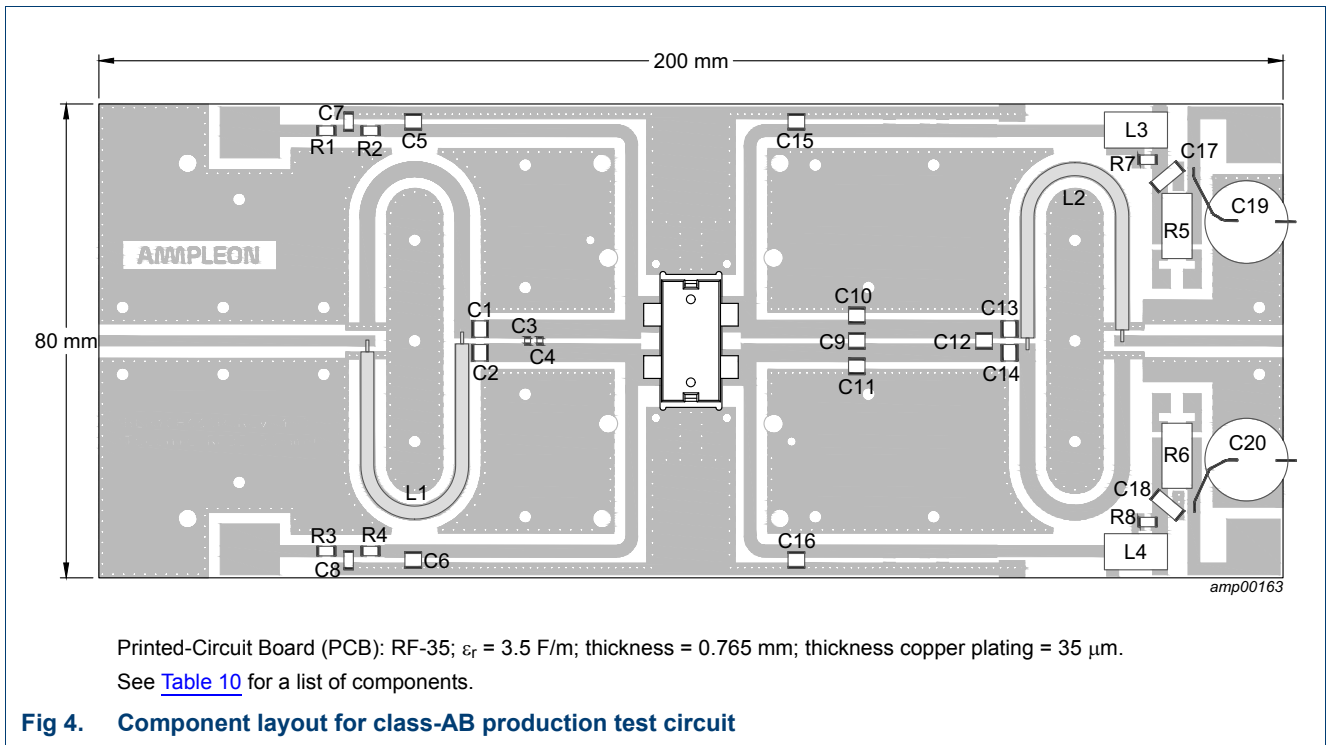
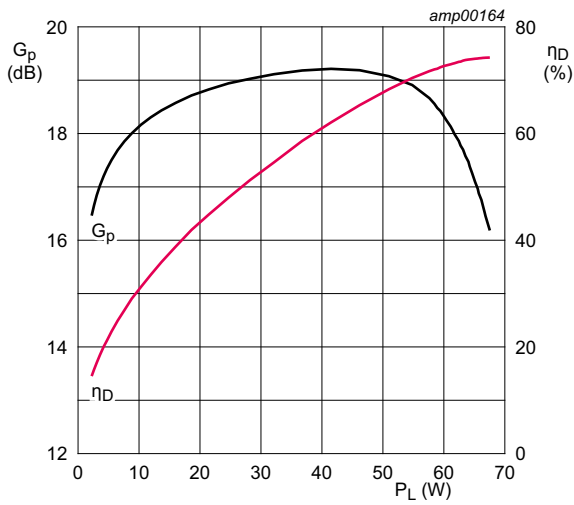


Table 10. List of components

For test circuit see [Figure 4](#).

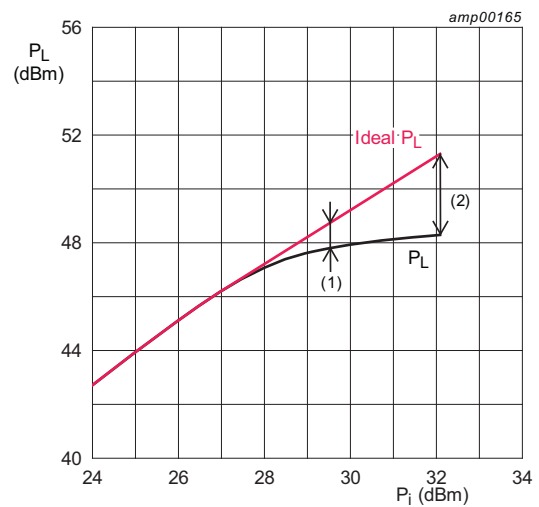
Component	Description	Value	Remarks
C1, C2	multilayer ceramic chip capacitor	33 pF	ATC 800B
C3	multilayer ceramic chip capacitor	4.3 pF	ATC 100A
C4	multilayer ceramic chip capacitor	4.7 pF	ATC 100A
C5, C6	multilayer ceramic chip capacitor	150 pF	ATC 100A
C7, C8	electrolytic capacitor	1 μ F, 50 V	GRM32RR71H105KA01L
C9	multilayer ceramic chip capacitor	10 pF	ATC 800B
C10, C11	multilayer ceramic chip capacitor	5.6 pF	ATC 800B
C12	multilayer ceramic chip capacitor	5.6 pF	ATC 800B
C13, C14	multilayer ceramic chip capacitor	27 pF	ATC 800B
C15, C16	multilayer ceramic chip capacitor	150 pF	ATC 800B
C17, C18	multilayer ceramic chip capacitor	4.7 μ F, 100 V	TDK: C5750X7R2A475KT/A
C19, C20	electrolytic capacitor	1000 μ F, 63 V	Vishay
L1	coaxial balun	L = 64.8 mm	EZ_86_TP_M17
L2	coaxial balun	L = 64.8 mm	EZ_86_TP_M17
L3, L4	inductor	90 nH	132-9SMGL
R1, R2, R3, R4	resistor	4.7 Ω	SMD 1206
R5, R6	resistor	50 m Ω , 5 W	FC4L110R010FER
R7, R8	resistor	7.5 Ω	SMD 1206

7.4 Graphical data



$V_{DS} = 50\text{ V}$; $I_{Dq} = 40\text{ mA}$; $f = 720\text{ MHz}$; $t_p = 100\text{ }\mu\text{s}$;
 $\delta = 20\text{ }\%$.

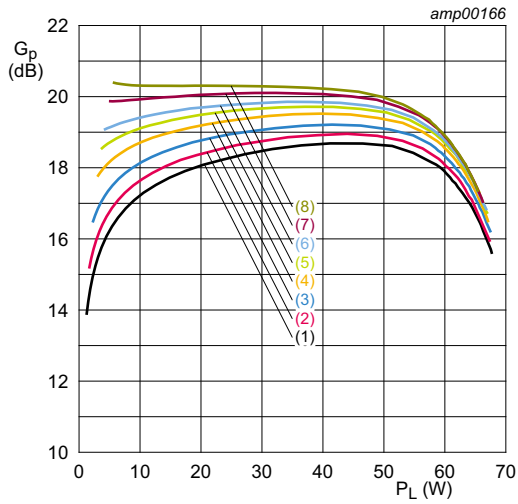
Fig 5. Power gain and drain efficiency as function of output power; typical values



$V_{DS} = 50\text{ V}$; $I_{Dq} = 40\text{ mA}$; $f = 720\text{ MHz}$; $t_p = 100\text{ }\mu\text{s}$;
 $\delta = 20\text{ }\%$.

- (1) $P_{L(1dB)} = 47.8\text{ dBm}$ (60 W) at $P_i = 29.5\text{ dBm}$
- (2) $P_{L(3dB)} = 48.3\text{ dBm}$ (67.5 W) at $P_i = 32.1\text{ dBm}$

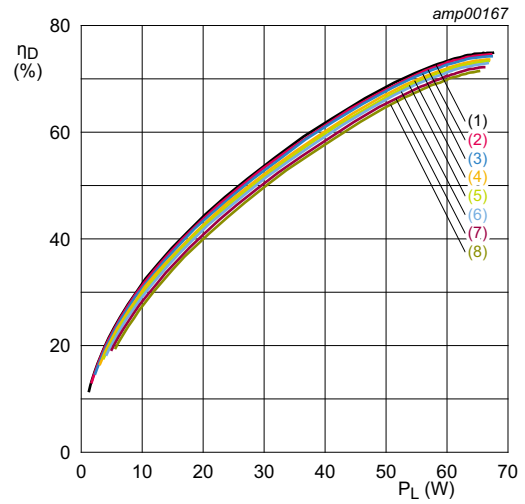
Fig 6. Output power as a function of input power; typical values



$V_{DS} = 50 \text{ V}$; $f = 720 \text{ MHz}$; $t_p = 100 \text{ }\mu\text{s}$; $\delta = 20 \text{ \%}$.

- (1) $I_{Dq} = 10 \text{ mA}$
- (2) $I_{Dq} = 20 \text{ mA}$
- (3) $I_{Dq} = 40 \text{ mA}$
- (4) $I_{Dq} = 80 \text{ mA}$
- (5) $I_{Dq} = 120 \text{ mA}$
- (6) $I_{Dq} = 160 \text{ mA}$
- (7) $I_{Dq} = 240 \text{ mA}$
- (8) $I_{Dq} = 320 \text{ mA}$

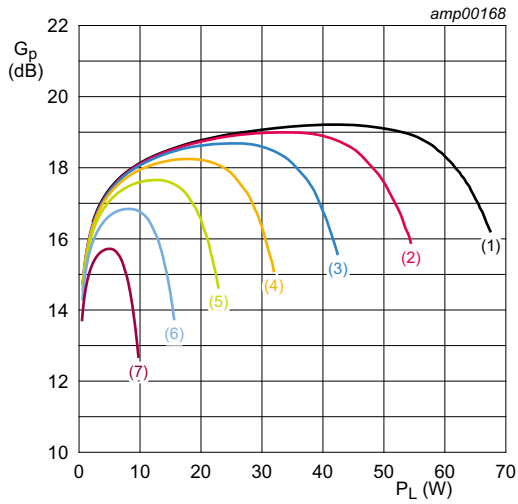
Fig 7. Power gain as a function of output power; typical values



$V_{DS} = 50 \text{ V}$; $f = 720 \text{ MHz}$; $t_p = 100 \text{ }\mu\text{s}$; $\delta = 20 \text{ \%}$.

- (1) $I_{Dq} = 10 \text{ mA}$
- (2) $I_{Dq} = 20 \text{ mA}$
- (3) $I_{Dq} = 40 \text{ mA}$
- (4) $I_{Dq} = 80 \text{ mA}$
- (5) $I_{Dq} = 120 \text{ mA}$
- (6) $I_{Dq} = 160 \text{ mA}$
- (7) $I_{Dq} = 240 \text{ mA}$
- (8) $I_{Dq} = 320 \text{ mA}$

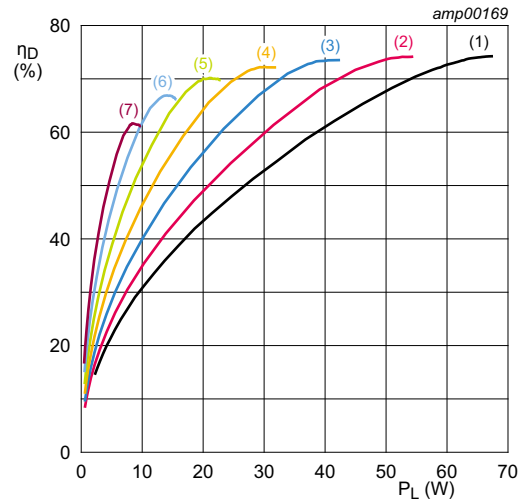
Fig 8. Drain efficiency as a function of output power; typical values



$I_{Dq} = 40 \text{ mA}$; $f = 720 \text{ MHz}$; $t_p = 100 \text{ }\mu\text{s}$; $\delta = 20 \text{ \%}$.

- (1) $V_{DS} = 50 \text{ V}$
- (2) $V_{DS} = 45 \text{ V}$
- (3) $V_{DS} = 40 \text{ V}$
- (4) $V_{DS} = 35 \text{ V}$
- (5) $V_{DS} = 30 \text{ V}$
- (6) $V_{DS} = 25 \text{ V}$
- (7) $V_{DS} = 20 \text{ V}$

Fig 9. Power gain as a function of output power; typical values



$I_{Dq} = 40 \text{ mA}$; $f = 720 \text{ MHz}$; $t_p = 100 \text{ }\mu\text{s}$; $\delta = 20 \text{ \%}$.

- (1) $V_{DS} = 50 \text{ V}$
- (2) $V_{DS} = 45 \text{ V}$
- (3) $V_{DS} = 40 \text{ V}$
- (4) $V_{DS} = 35 \text{ V}$
- (5) $V_{DS} = 30 \text{ V}$
- (6) $V_{DS} = 25 \text{ V}$
- (7) $V_{DS} = 20 \text{ V}$

Fig 10. Drain efficiency as a function of output power; typical values

8. Package outline

HSOP4F: plastic, heatsink small outline package; 4 leads(flat)

SOT1223-2

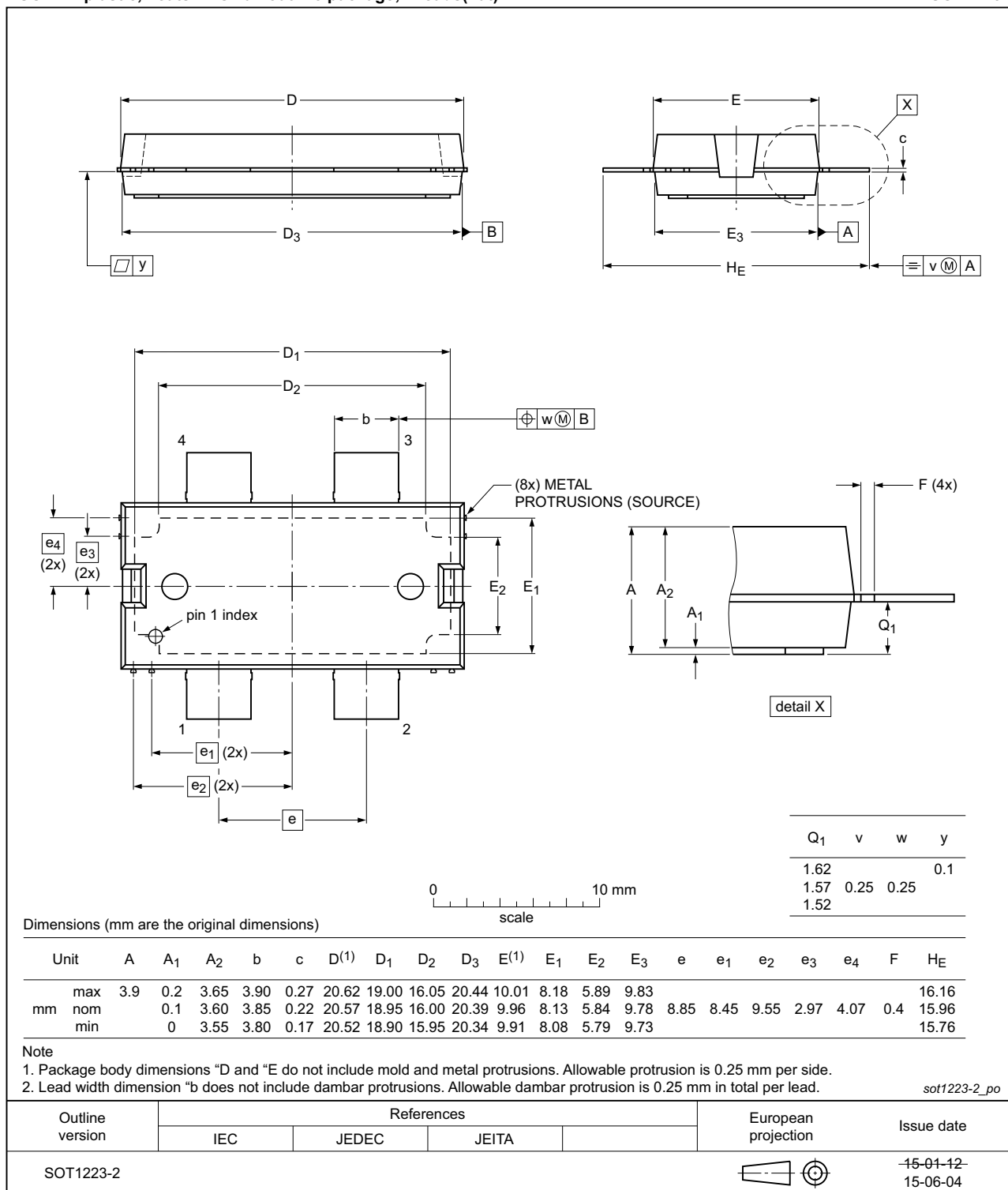


Fig 11. Package outline SOT1223-2 (HSOP4F)

HSOP4: plastic, heatsink small outline package; 4 leads

SOT1224-2

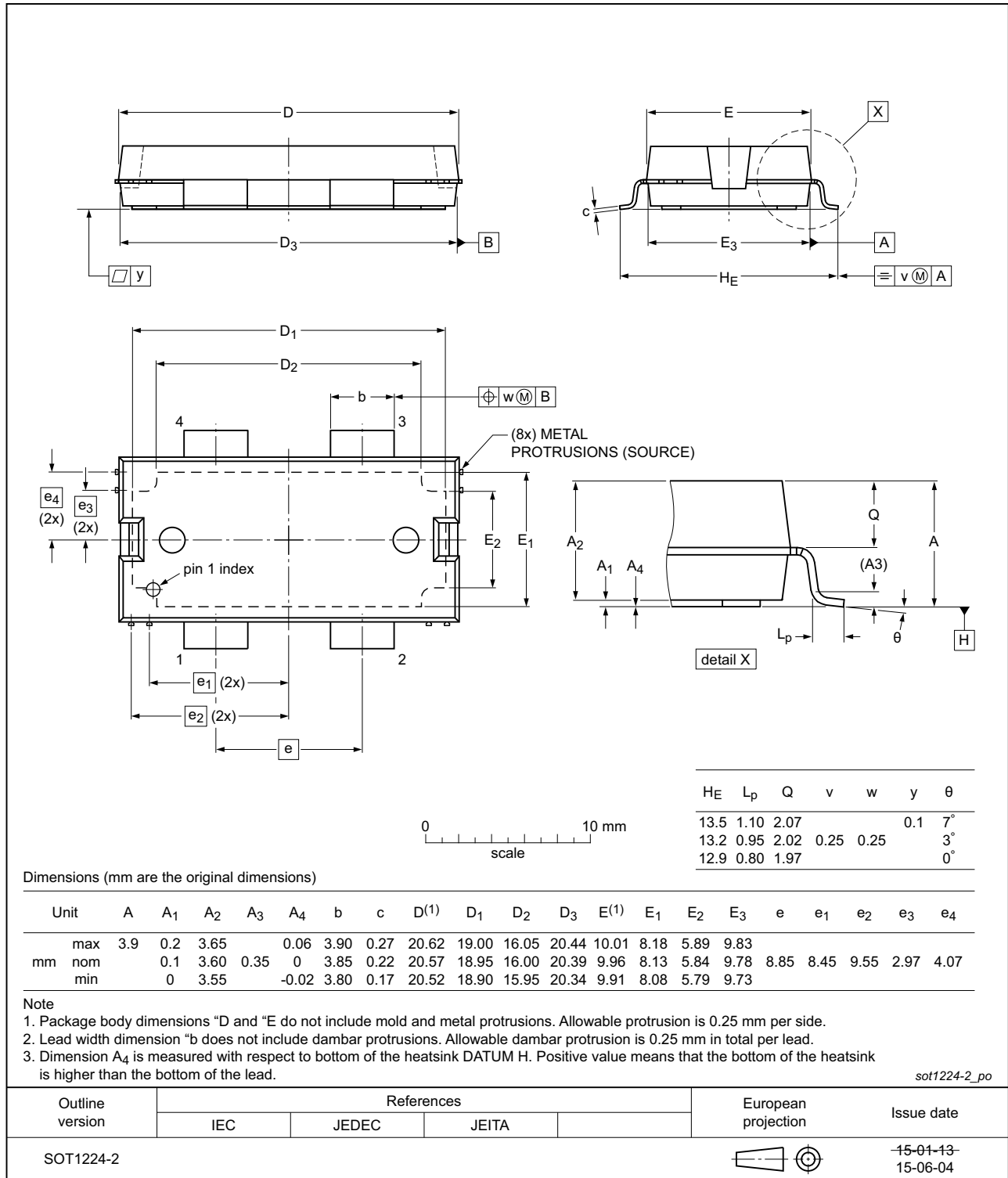


Fig 12. Package outline SOT1224-2 (HSOP4)

9. Handling information


CAUTION	
	<p>This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.</p> <p>Such precautions are described in the <i>ANSI/ESD S20.20</i>, <i>IEC/ST 61340-5</i>, <i>JESD625-A</i> or equivalent standards.</p>

Table 11. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C1 [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1C [2]

- [1] CDM classification C1 is granted to any part that passes after exposure to an ESD pulse of 250 V, but fails after exposure to an ESD pulse of 500 V.
- [2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V, but fails after exposure to an ESD pulse of 2000 V.

10. Abbreviations

Table 12. Abbreviations

Acronym	Description
CW	Continuous Wave
ESD	ElectroStatic Discharge
HF	High Frequency
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLP10H660P_BLP10H660PG v.1	20161220	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[2] The term 'short data sheet' is explained in section "Definitions".

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